

NX7460LE

1 480 nm EDFA APPLICATION InGaAsP STRAINED MQW DC-PBH LASER DIODE MODULE

DESCRIPTION

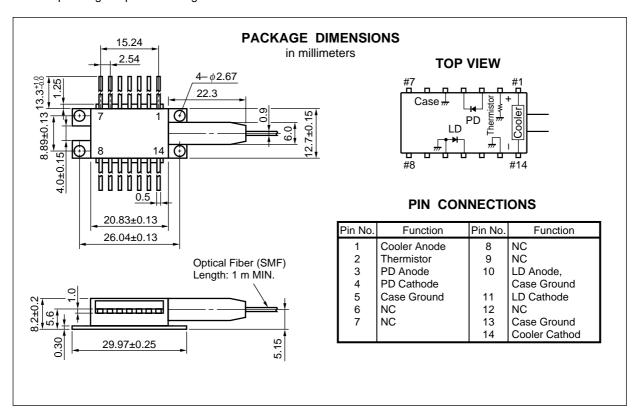
The NX7460LE is a 1 480 nm pumping laser diode module with optical isolator for an EDFA (Er Doped optical Fiber Amplifier) that can expand the transmission span and compensate optical losses. It has a strained Multiple Quantum Well (st-MQW) DC-PBH laser diode that features high output power, high efficiency, and stable fundamental mode.

FEATURES

- InGaAsP strained MQW DC-PBH laser diode
- ★ High output power

Pf = 120 mW MIN. @ IF = 550 mA CW

- · Internal optical isolator, thermoelectric cooler and InGaAs monitor photo diode
- · Hermetically sealed 14-pin butterfly package
- · Single mode fiber pigtail
- ★ Wide operating temperature range
 Tc = 0 to +65 °C



The information in this document is subject to change without notice. Before using this document, please confirm that this is the latest version. Not all devices/types available in every country. Please check with local NEC representative for availability and additional information.



ORDERING INFORMATION

| Part Number | Available Connector |
|-------------|----------------------|
| NX7460LE | Without Connector |
| NX7460LE-BA | With FC-PC Connector |
| NX7460LE-CA | With SC-PC Connector |

ABSOLUTE MAXIMUM RATINGS (Tc = 25 °C, unless otherwise specified)

| Parameter | Symbol | Ratings | Unit |
|-----------------------------------|--------|------------|------|
| Forward Current of LD | lF | 700 | mA |
| Reverse Voltage of LD | Vr | 2.0 | V |
| Forward Current of PD | lF | 10 | mA |
| Reverse Voltage of PD | VR | 20 | V |
| Operating Case Temperature | Tc | -20 to +65 | °C |
| Storage Temperature | Tstg | -40 to +85 | °C |
| Lead Soldering Temperature (10 s) | Tsld | 260 | °C |

★ ELECTRO-OPTICAL CHARACTERISTICS (TLD = 25 °C, Tc = 0 to +65 °C)

| Parameter | Symbol | Conditions | MIN. | TYP. | MAX. | Unit |
|---------------------------------|--------|---------------------------------------|-------|-------|-------|------|
| Threshold Current | Ith | cw | | 25 | 35 | mA |
| Forward Voltage | VF | I _F = 550 mA | | 2.2 | 2.7 | V |
| Optical Output Power from Fiber | Pf | I _F = 550 mA | 120 | 140 | | mW |
| Center Wavelength | λο | I _F = 550 mA, RMS (-20 dB) | 1 470 | 1 480 | 1 490 | nm |
| Spectrum Width | σ | I _F = 550 mA, RMS (-20 dB) | | 4.0 | 8.0 | nm |
| Isolation | ls | 1 470 nm to 1 490 nm | 20 | | | dB |

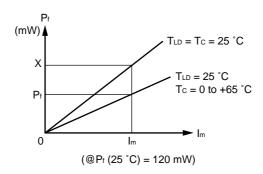
2

★ ELECTRO-OPTICAL CHARACTERISTICS

(Applicable to Monitor PD: TLD = 25 °C, Tc = 0 to +65 °C)

| Parameter | Symbol | Conditions | MIN. | TYP. | MAX. | Unit |
|----------------------|--------|---|------|-------|-------|------|
| Monitor Current | lm | V _R = 5 V, I _F = 550 mA | 500 | 1 000 | 1 500 | μΑ |
| Monitor Dark Current | lσ | V _R = 5 V | | 2.0 | 10 | nA |
| Tracking Error | γ*1 | Im = const. | | | 0.5 | dB |

*1
$$\gamma = \left| 10 \log \frac{P_f}{120 \text{ mW}} \right|$$



* ELECTRO-OPTICAL CHARACTERISTICS

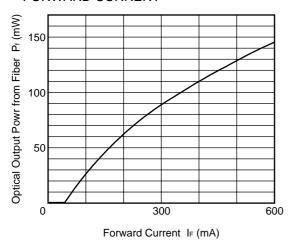
(Applicable to Thermistor and TEC: TLD = 25 °C, Tc = 0 to +65 °C)

| Parameter | Symbol | Conditions | MIN. | TYP. | MAX. | Unit |
|-----------------------|-----------------|--------------------------------------|-------|-------|-------|------|
| Thermistor Resistance | R | T _{LD} = 25 °C | 9.5 | 10.0 | 10.5 | kΩ |
| B Constant | В | | 3 300 | 3 400 | 3 500 | K |
| Cooler Current | Ic | $\Delta T = 40 \text{ K}$ | | 1.0 | 1.25 | Α |
| Cooler Voltage | Vc | $\Delta T = 40 \text{ K}$ | | 3.5 | 4.3 | V |
| Cooling Capacity | ΔT^{*1} | Ic = 1.25 A, I _F = 660 mA | 40 | | | K |

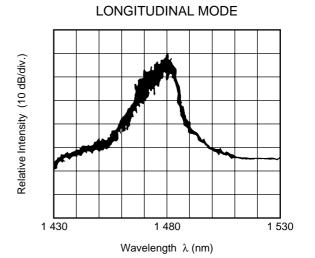
*1
$$\Delta T = |T_C - T_{LD}|$$

TYPICAL CHARACTERISTICS (Tc = 25 °C)

OPTICAL OUTPUT POWER FROM FIBER vs. FORWARD CURRENT



Remark The graphs indicate nominal characteristics.





LD FAMILY FOR DENSE WDM APPLICATION

| | Absolute Max | imum Ratings | Typic | al Characte | ristics | | |
|---------------|--------------|--------------------------|----------------------|------------------------|---------------------|--------------------------------------|---------|
| Part Number | Tc (°C) | T _{stg} (°C) | I _{th} (mA) | P _f (mW) | λc (nm) | Description | Package |
| | | | TYP. | MIN. | TYP. | | |
| NDL7540PA | -20 to +65 | -40 to +85 | 40 | 90 | 1 480 | 1 480 nm pump LD module | BFY |
| NX7460LE | 0 to +65 | -40 to +85 | 25 | 120 | 1 480 | 1 480 nm pump LD module | BFY |
| NX8501 Series | 0 to +65 | -40 to +85 | 20 | 2 | 1 510 | Telemetry | Coaxial |
| NX8561JD*1 | 0 to +65 | -40 to +85 | 20 | 3 | 1 510 | Telemetry | DIP |
| NX7660JC*1 | -20 to +65 | -40 to +85 | 15 | 5 | 1 625 | Telemetry | DIP |
| NDL7910P | -20 to +70 | -40 to +85 | 7 | 0.5 | 1 550 ^{*2} | 2.5 G EA modulator integrated module | BFY |
| NX8562LB | -20 to +65 | -40 to +85 | 20 | 20 | 1 550 ^{*2} | 1 550 CW LD module | BFY |
| NX8563LB | -20 to +65 | -40 to +85 | 20 | 10 | ITU-T ^{*3} | 1 550 CW LD module | BFY |

^{*1} Under development

5

NX7460LE

^{*2} Wavelength selectable for ITU-T standards upon request

^{*3} Wavelength selectable for ITU-T standards

REFERENCE

| Document Name | Document No. |
|---|--------------|
| NEC semiconductor device reliability/quality control system | C11159E |
| Quality grades on NEC semiconductor devices | C11531E |
| Semiconductor device mounting technology manual | C10535E |
| SEMICONDUCTOR SELECTION GUIDE Products & Packages (CD-ROM) | X13769X |

*

CAUTION

Within this device there exists GaAs (Gallium Arsenide) material which is a harmful substance if ingested. Please do not under any circumstances break the hermetic seal.



| NEC Corporation NEC Building, 7-1, Shiba 5-chome, Minato-ku, Tokyo 108-01, Japan |
|--|
| Type number: |
| Manufactured: |
| Serial Number: |
| This product conforms to FDA |
| regulations as applicable |
| to standards 21 CFR Chapter 1. |
| Subchapter J. |

7

The export of this product from Japan is prohibited without governmental license. To export or re-export this product from a country other than Japan may also be prohibited without a license from that country. Please call an NEC sales representative.

- The information in this document is subject to change without notice. Before using this document, please confirm that this is the latest version.
- No part of this document may be copied or reproduced in any form or by any means without the prior written
 consent of NEC Corporation. NEC Corporation assumes no responsibility for any errors which may appear in
 this document.
- NEC Corporation does not assume any liability for infringement of patents, copyrights or other intellectual property
 rights of third parties by or arising from use of a device described herein or any other liability arising from use
 of such device. No license, either express, implied or otherwise, is granted under any patents, copyrights or other
 intellectual property rights of NEC Corporation or others.
- Descriptions of circuits, software, and other related information in this document are provided for illustrative purposes in semiconductor product operation and application examples. The incorporation of these circuits, software, and information in the design of the customer's equipment shall be done under the full responsibility of the customer. NEC Corporation assumes no responsibility for any losses incurred by the customer or third parties arising from the use of these circuits, software, and information.
- While NEC Corporation has been making continuous effort to enhance the reliability of its semiconductor devices, the possibility of defects cannot be eliminated entirely. To minimize risks of damage or injury to persons or property arising from a defect in an NEC semiconductor device, customers must incorporate sufficient safety measures in its design, such as redundancy, fire-containment, and anti-failure features.
- NEC devices are classified into the following three quality grades:
 - "Standard", "Special", and "Specific". The Specific quality grade applies only to devices developed based on a customer designated "quality assurance program" for a specific application. The recommended applications of a device depend on its quality grade, as indicated below. Customers must check the quality grade of each device before using it in a particular application.
 - Standard: Computers, office equipment, communications equipment, test and measurement equipment, audio and visual equipment, home electronic appliances, machine tools, personal electronic equipment and industrial robots
 - Special: Transportation equipment (automobiles, trains, ships, etc.), traffic control systems, anti-disaster systems, anti-crime systems, safety equipment and medical equipment (not specifically designed for life support)
 - Specific: Aircraft, aerospace equipment, submersible repeaters, nuclear reactor control systems, life support systems or medical equipment for life support, etc.

The quality grade of NEC devices is "Standard" unless otherwise specified in NEC's Data Sheets or Data Books. If customers intend to use NEC devices for applications other than those specified for Standard quality grade, they should contact an NEC sales representative in advance.